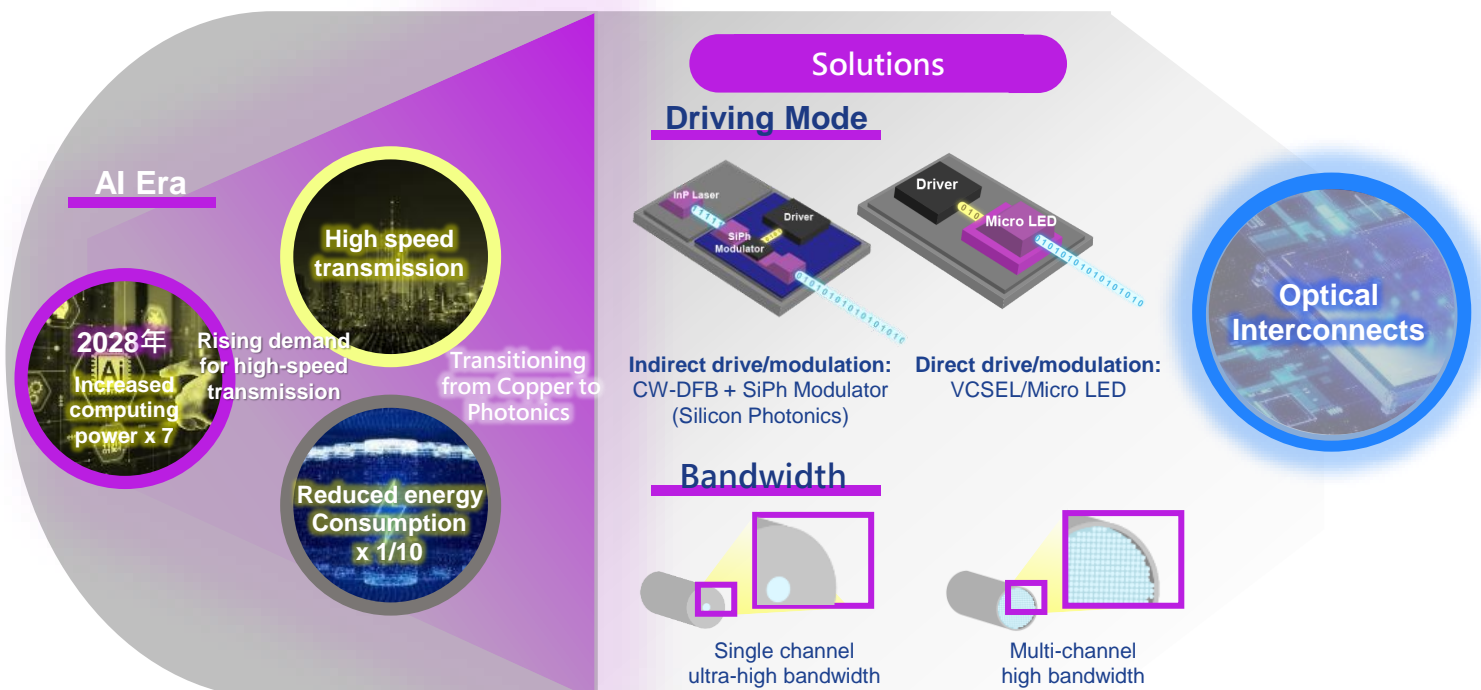


Emerging Market

AI Optical Interconnects

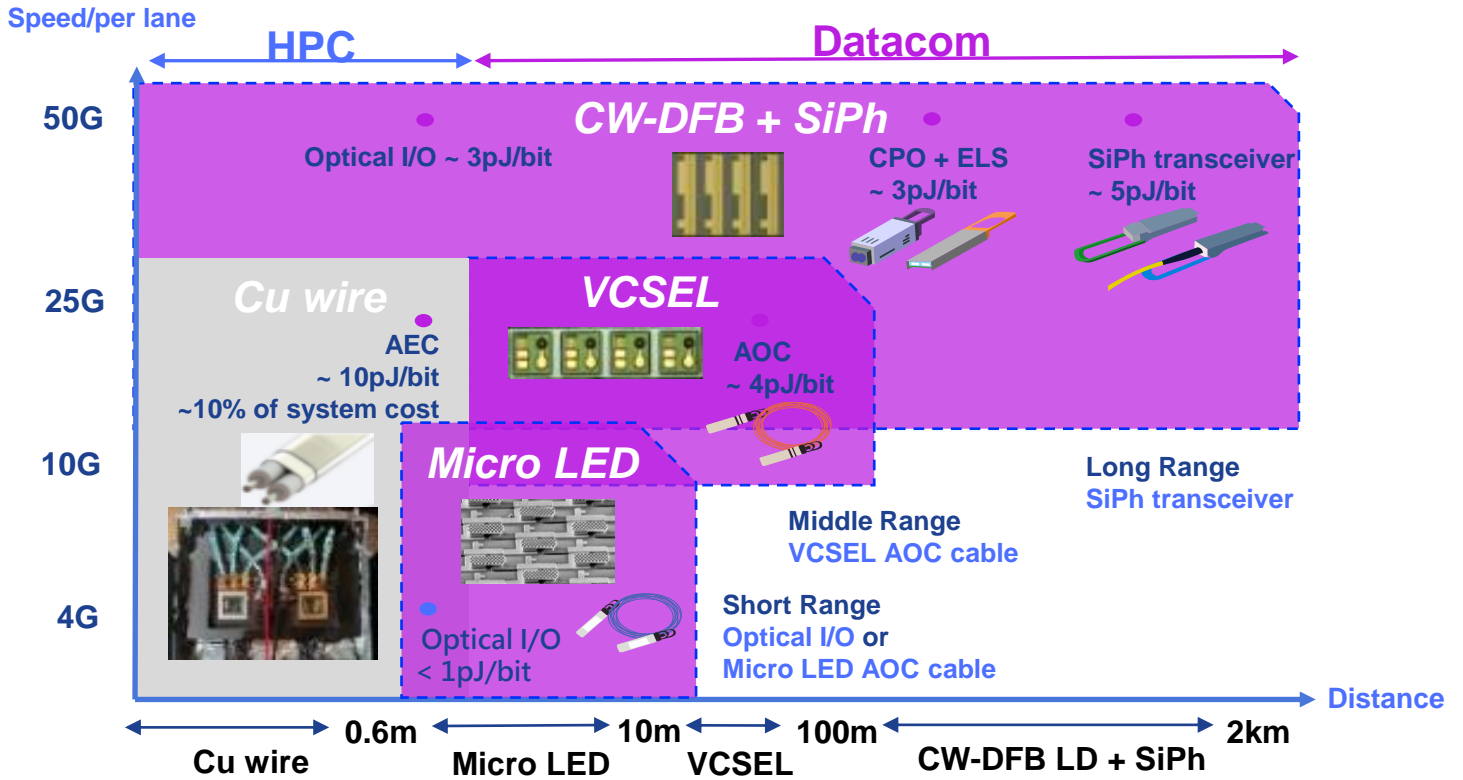
As AI applications expand, global data traffic is expected to grow sevenfold by 2028, driving the demand for high-speed transmission. Traditional copper wire technology is limited by energy consumption and bandwidth, while optical interconnect, with its advantages of single-channel multi-wavelength and multi-channel high bandwidth, is poised to become the new technology for high-speed transmission. Leveraging its expertise and experience in III-V semiconductor materials and processes, Ennostar is actively developing new light sources such as VCSEL, CW-DFB LD, and Micro LED to achieve high-efficiency, low-power transmission. This will meet the needs of AI training and data center transmission, accelerate cloud and IoT applications, and drive a new era of information transmission revolution.

Optical Interconnects are the Key Answer for Transmission in AI Era



AI Optical Interconnects

Positions of Three AI Optical Interconnect Technologies



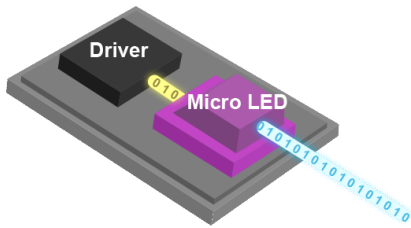
Advantages of Three AI Optical Interconnect Technologies

Ennostar

Item	Electrical	Micro LED	VCSEL	CW-DFB LD
Max. reach (m)	1	10	100	2000
Link energy (pJ/bit)	> 10	<1	4	5
Max. operating temp (°C)	125	125	85	75
Pre-FEC bit error ratio	10 ⁻¹⁸	<10 ⁻¹²	2.4 x 10 ⁻⁴	2.4 x 10 ⁻⁴
Redundancy	N/A	Yes	N/A	N/A
Latency	Low	Low	Medium	Medium
integration with CMOS	Easy	Easy	Medium	Hard
Relative Cost (Per bit)	Low	Low	Medium	High

AI Optical Interconnects

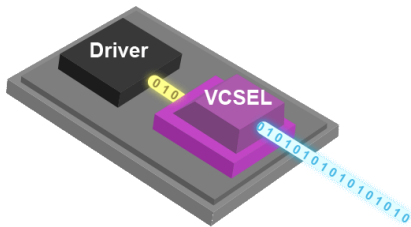
Advantages of Three AI Optical Interconnect Technologies



Micro LED (Best Cost-Effectiveness for Transmission within 10 Meters)

< 10 m
125 °C
30,000hr
1 pJ/bit

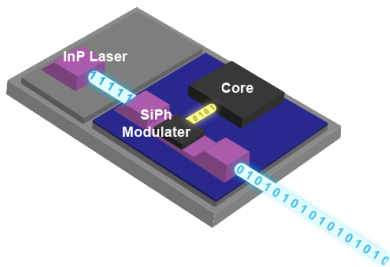
- Low cost
- High temperature resistance
- Long lifespan
- Low energy consumption



VCSEL (Best Cost Efficiency for Mid-Range Transmission)

< 100 m
85 °C
5,000hr
4 pJ/bit

- The most widely used optical source
- A mature supply chain
- Easier optical integration



CW-DFB LD (Efficient Long-Distance Transmission)

< 2 km
75 °C
5,000hr
5 pJ/bit

- Paired with silicon photonics for broader coverage
- Semiconductor silicon photonics ecosystem is stronger
- Relatively higher cost

Ennostar's Three Major AI Optical Interconnect Technologies Development Roadmap from 2025 to 2028

Micro LED — 1Gbps — 4Gbps — 6Gbps — 8Gbps →

VCSEL — 50Gbps — 100Gbps — 200Gbps →

CW-DFB LD — 70mW — 100mW — 150mW — 200mW →